56Vac...891Vac input from Three-phase Mains
65 V ... 1260 V


NOTES:
Built on PMP10195 Rev_A PWB; Ref. Des. > 99 have been added on the board
Disconnect D21-K and R32 from pin 4 and connect to pin pin 5 of U1
Swap D21 Anode with Cathode (populate it top-down) on the board
Disconnect C18 from ground and connect it to pin 2 of U1

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